

10AS016E3F27I2LG Information

Heisener.com

Part Number 10AS016E3F27I2LG

Manufacturer Intel

Category Integrated Circuits (ICs)

Embedded - System On Chip (SoC)

Description IC SOC FPGA 240 I/O 672FBGA

Package 672-BBGA, FCBGA

For the pricing/inventory/lead time, please contact

us

For Reference Only

Website: https://www.heisener.com

E-mail: salesdept@heisener.com



Request a Quote

Certified Quality

Heisener's commitment to quality has shaped our processes for sourcing, testing, shipping, and every step in between. This foundation underlies each component we sell.









10AS016E3F27I2LG Specifications

		Report errors?
Supplier Device Package	672-FBGA (27x27)	
Package / Case	672-BBGA, FCBGA	
Operating Temperature	-40°C ~ 100°C (TJ)	
Primary Attributes	FPGA - 160K Logic Elements	
Speed	1.5GHz	
Connectivity	EBI/EMI, Ethernet, I2C, MMC/SD/SDIO, SPI, UART/USART, USB OTG	
Peripherals	DMA, POR, WDT	
RAM Size	256KB	
Flash Size	-	
Core Processor	Dual ARM® Cortex®-A9 MPCore™ with CoreSight™	
Architecture	MCU, FPGA	
Series	Arria 10 SX	
Package	672-BBGA, FCBGA	
	Embedded - System On Chip (SoC)	
Category	Integrated Circuits (ICs)	
Manufacturer	Intel	
Manufacturer Part Number	10AS016E3F27I2LG	

10AS016E3F27I2LG Guarantees



Quality Guarantees

We provide 90 days warranty. *

If the items you received were not in perfect quality, we would be responsible for your refund or replacement, but the items must be returned in their original condition.



Service Guarantees

We guarantee 100% customer satisfaction.

Our experienced sales team and tech support team back our services to satisfy all our customers.

10AS016E3F27I2LG Payment Methods





















10AS016E3F27I2LG Shipping Methods













If you have any question about 10AS016E3F27I2LG, please do not hesitate to contact us!

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